

Cree® XLamp® MX-6 LEDs



PRODUCT DESCRIPTION

The Cree XLamp MX-6 LED provides the proven lighting-class performance and reliability of Cree XLamp LEDs in a flat-top PLCC package. The XLamp MX-6 LED continues Cree's history of innovation in LEDs for lighting applications with wide viewing angle, unlimited floor life, uniform light output without secondary optics and electrically neutral thermal path.

The XLamp MX-6 LED brings high performance and quality of light to a wide range of lighting applications, including linear lighting, LED light bulbs, fluorescent retrofits and retail-display lighting.

FEATURES

- Available in white (2200 K and 2600 K to 8300 K CCT)
- Maximum drive current: 1000 mA
- Wide viewing angle: 120°
- Electrically neutral thermal path
- Qualification at max drive current
- RoHS- and REACH-compliant
- UL-recognized component (E326295)



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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		5	
Viewing angle (FWHM)	degrees		120	
Temperature coefficient of voltage	mV/°C		-3.3	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			1000
Forward voltage (@ 300 mA)	V		3.3	3.8
LED junction temperature	°C			150

FLUX CHARACTERISTICS ($T_j = 25\text{ }^{\circ}\text{C}$)

The following table provides several base order codes for XLamp MX-6 LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp MX-6 LED Binning & Labeling document.

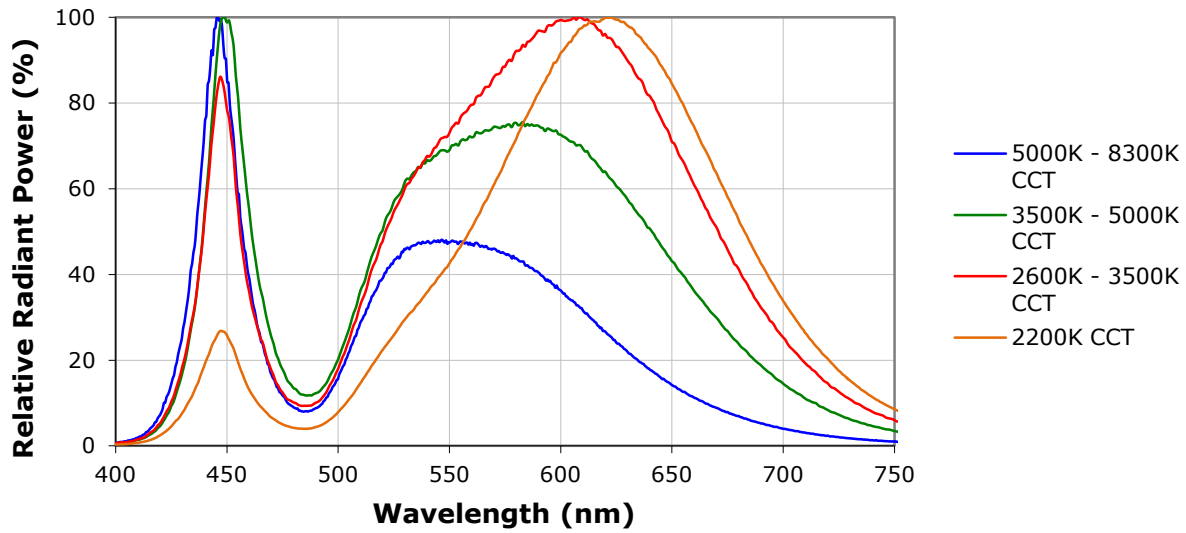
Color	CCT Range		Base Order Codes Min. Luminous Flux (lm) @ 300 mA		Calculated Min. Luminous Flux (lm) @ 350 mA*	Order Code
	Min.	Max.	Group	Flux (lm)	Flux (lm)	
Cool White	5000 K	8300 K	Rs	114	130	MX6AWT-A1-0000-000E51
			Q5	107	122	MX6AWT-A1-0000-000D51
			Q5	107	122	MX6AWT-A1-0000-000DE3
			Q4	100	114	MX6AWT-A1-0000-000CE3
80-CRI White	5000 K	8300 K	Q5	107	122	MX6AWT-H1-0000-000D51
			Q4	100	114	MX6AWT-H1-0000-000C51
			Q5	107	122	MX6AWT-H1-0000-000DE3
			Q4	107	114	MX6AWT-H1-0000-000CE3
	3700 K	4300 K	Q4	100	114	MX6AWT-H1-0000-000CE5
			Q3	93.9	107	MX6AWT-H1-0000-000BE5
	2600 K	3700 K	Q3	93.9	107	MX6AWT-H1-0000-000BE7
			Q2	87.4	100	MX6AWT-H1-0000-000AE7
Warm White	3700 K	4300 K	Q4	100	114	MX6AWT-A1-0000-000CE5
			Q3	93.9	107	MX6AWT-A1-0000-000BE5
	2600 K	3700 K	Q3	93.9	107	MX6AWT-A1-0000-000BE7
			Q2	87.4	100	MX6AWT-A1-0000-000AE7
	2200 K		P4	80.6	92	MX6AWT-A1-0000-0009EA
			P3	73.9	84	MX6AWT-A1-0000-0008EA
			P2	67.2	77	MX6AWT-A1-0000-0007EA

* Calculated values for reference purposes only.

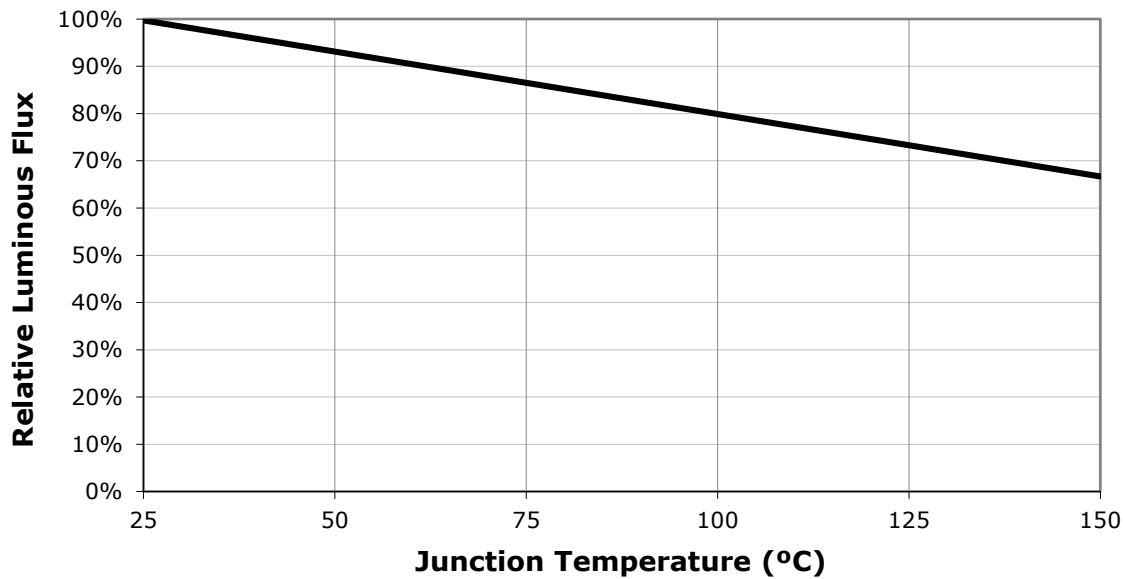
Notes:

- Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements, ± 0.005 on chromaticity (CCx, CCy) measurements and ± 2 on CRI measurements.
- Typical CRI for Cool White (4300 K – 8300 K CCT) is 75.
- Typical CRI for Warm White (2200 K and 2600 K – 4300 K CCT) is 80.
- Minimum CRI for 80-CRI White is 80.

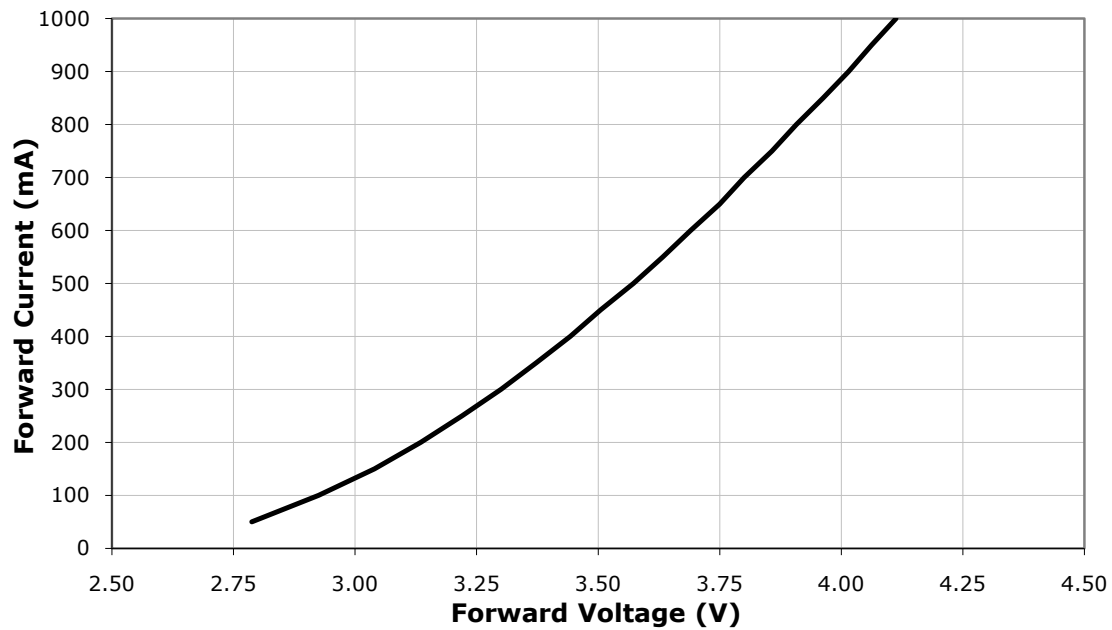
RELATIVE SPECTRAL POWER DISTRIBUTION



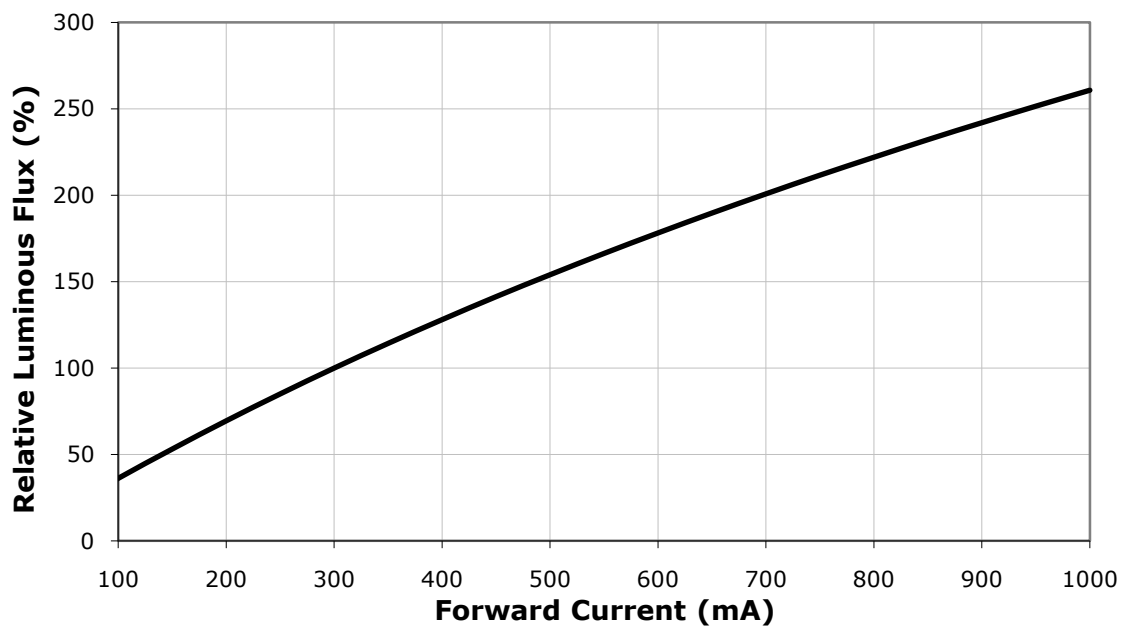
RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 300\text{ MA}$)



ELECTRICAL CHARACTERISTICS ($T_j = 25\text{ }^{\circ}\text{C}$)



RELATIVE FLUX VS. CURRENT ($T_j = 25\text{ }^{\circ}\text{C}$)



THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.



TYPICAL SPATIAL DISTRIBUTION



REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp MX-6 LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts _{min})	100 °C	150 °C
Preheat: Temperature Max (Ts _{max})	150 °C	200 °C
Preheat: Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (TL)	183 °C	217 °C
Time Maintained Above: Time (tL)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to the topside of the package, measured on the package body surface.

NOTES

Lumen Maintenance Projections

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document at www.cree.com/xlamp_app_notes/LM80_results.

Please read the XLamp Long-Term Lumen Maintenance application note at www.cree.com/xlamp_app_notes/lumen_maintenance for more details on Cree's lumen maintenance testing and forecasting. Please read the XLamp Thermal Management application note at www.cree.com/xlamp_app_notes/thermal_management for details on how thermal design, ambient temperature and drive current affect the LED junction temperature.

Moisture Sensitivity

XLamp MX-6 LEDs are shipped in sealed, moisture-barrier bags (MBB) designed for long shelf life. If XLamp MX-6 LEDs are exposed to moist environments after opening the MBB packaging but before soldering, damage to the LED may occur during the soldering operation. The derating table at right defines the maximum exposure time (in days) for an XLamp MX-6 LED in the listed humidity and temperature conditions.

Temp.	Maximum Percent Relative Humidity						
	30%	40%	50%	60%	70%	80%	90%
35 °C	-	-	-	17	1	.5	.5
30 °C	-	-	-	28	1	1	1
25 °C	-	-	-	-	2	1	1
20 °C	-	-	-	-	2	1	1

LEDs with exposure time longer than the time specified below must be baked according to the baking conditions listed below.

Cree recommends keeping XLamp LEDs in their sealed moisture-barrier packaging until immediately prior to use. Cree also recommends returning any unused LEDs to the resealable moisture-barrier bag and closing the bag immediately after use.

Baking Conditions

It is not necessary to bake all XLamp MX-6 LEDs. Only the LEDs that meet all of the following criteria must be baked:

1. LEDs that have been removed from the original MBB packaging.
2. LEDs that have been exposed to a humid environment longer than listed in the Moisture Sensitivity section above.
3. LEDs that have not been soldered.

LEDs should be baked at 70 °C for 24 hours. LEDs may be baked on the original reels. Remove LEDs from MBB packaging before baking. Do not bake parts at temperatures higher than 70 °C. This baking operation resets the exposure time as defined in the Moisture Sensitivity section above.

Storage Conditions

XLamp MX-6 LEDs that have been removed from the original MBB packaging but not soldered should be stored in one of the following ways:

- Store the parts in a rigid metal container with a tight-fitting lid. Verify that the storage temperature is $<30^{\circ}\text{C}$, and place fresh desiccant and an RH indicator in the container to verify that the RH is no greater than 60%.
- Store the parts in a dry, nitrogen-purged cabinet or container that actively maintains the temperature at $<30^{\circ}$ and the RH at no greater than 60%.
- For short-term store only: LEDs can be resealed in the original MBB bag soon after opening. Fresh desiccant may be needed. Use the included humidity indicator card to verify $<60\%$ RH.

If an environment of $<60\%$ RH is not available for storage, XLamp MX-6 LEDs should be baked (described above) before reflow soldering.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as amended through June 8, 2011. RoHS Declarations for this product can be obtained from your Cree representative or obtained from the Product Ecology section of www.cree.com.

REACH Compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notices of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACH Declaration. Historical REACH banned substance information (substances restricted or banned in the EU prior to 2010) is also available upon request.

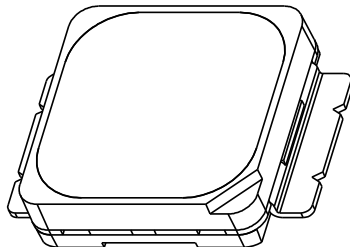
Vision Advisory Claim

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. See LED Eye Safety at www.cree.com/xlamp_app_notes/led_eye_safety.

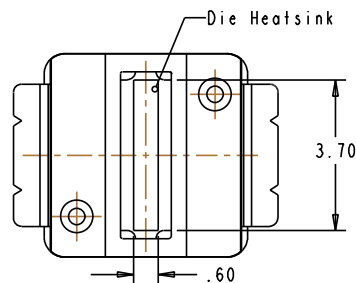
MECHANICAL DIMENSIONS

All measurements are ± 0.13 mm unless otherwise indicated.

Top View



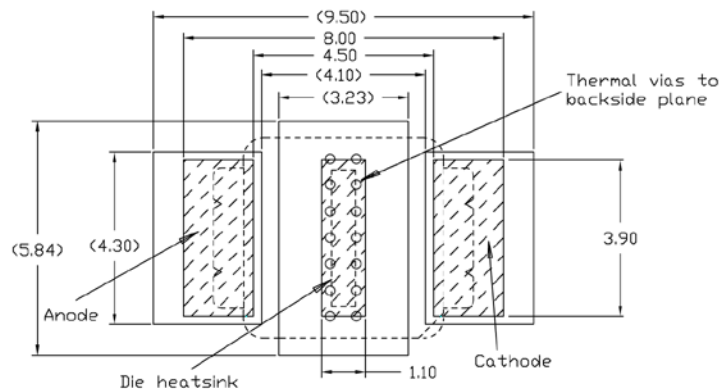
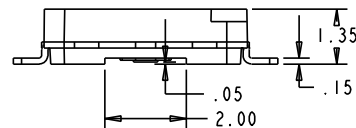
Bottom View



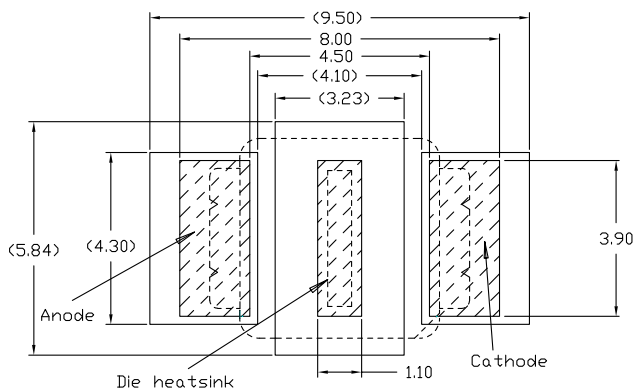
Top View



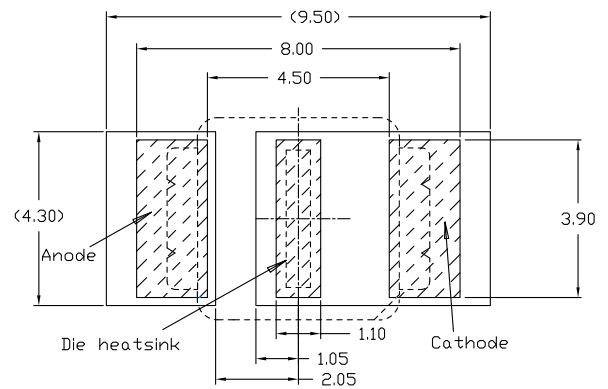
Side View



Recommended FR4 Solder Pad



Recommended MCPCB Solder Pad

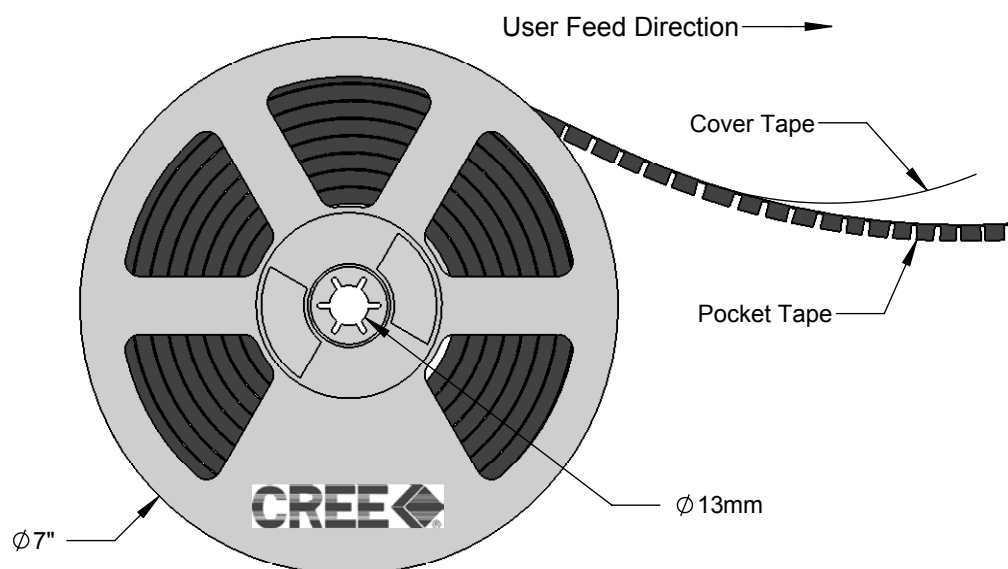
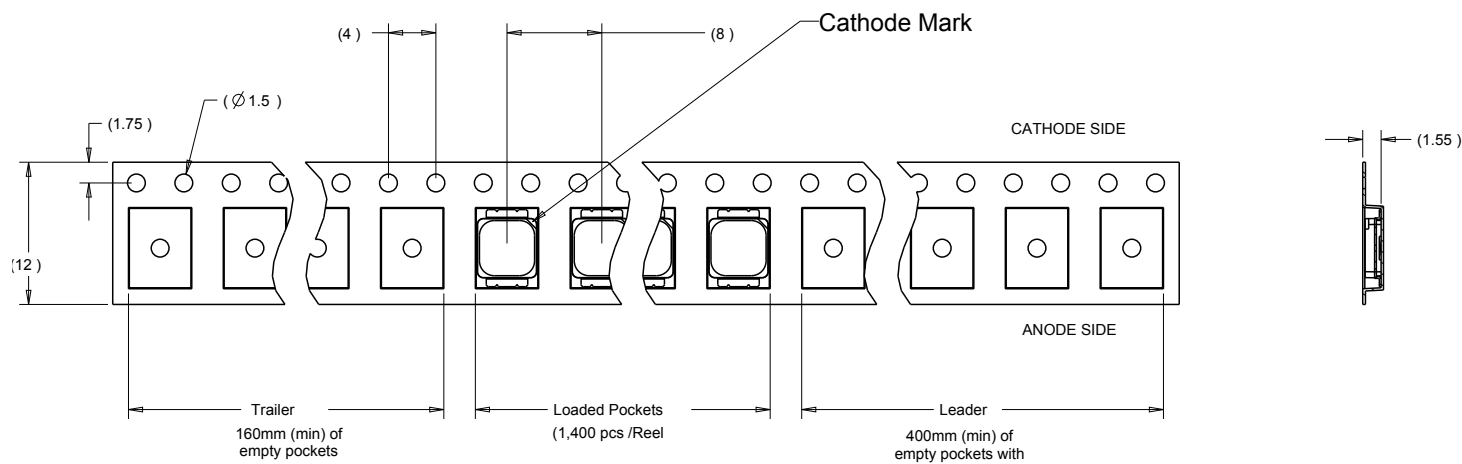


Alternative Solder Pad

TAPE AND REEL

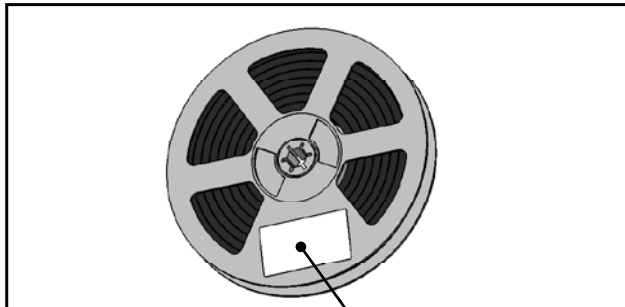
All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm.



PACKAGING

Unpackaged Reel



Label with Cree Bin
Code, Qty, Reel ID

Packaged Reel



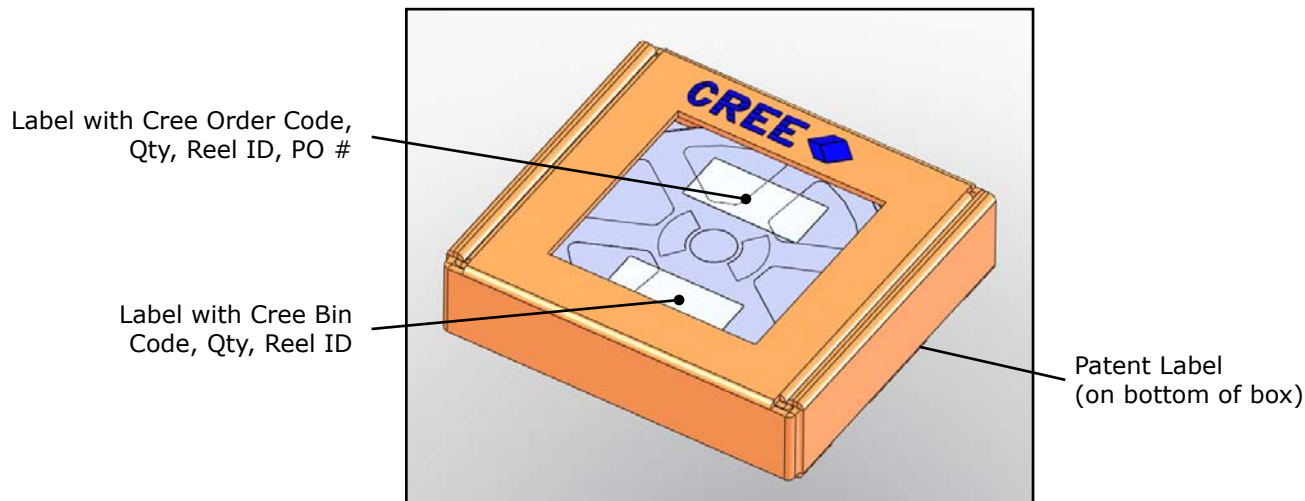
Dessicant
(inside bag)

Humidity Indicator Card
(inside bag)

Label with Cree Order Code,
Qty, Reel ID, PO #

Label with Cree Bin
Code, Qty, Reel ID

Boxed Reel



Label with Cree Order Code,
Qty, Reel ID, PO #

Label with Cree Bin
Code, Qty, Reel ID

Patent Label
(on bottom of box)

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

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- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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